



# FOAMS<sup>®</sup> 2016



14<sup>th</sup> International Conference on Advances in Foam Materials & Technology

SEPTEMBER 14-15 - SEATTLE, WA

## Call for Papers - FOAMS<sup>®</sup> 2016 Conference

Co-Sponsored by the Pacific Northwest Section & TPM&F Division of [The Society of Plastics Engineers](#)

The [FOAMS<sup>®</sup> 2016 conference](#) is planned to address the advances in synthesis, characterization, and properties of polymer foams by leading foam researchers in industry and academia. The conference will be held on September 14 and 15, 2016 in Seattle, Washington, USA. This conference is the premier forum for sharing ideas and learning about new developments in foaming technologies due to the diversity of the attendees.

### Program Committee, FOAMS 2016:

- Conference Chair: Dr. Xiaoxi Wang, The Boeing Company
- Technical Program Chair: Prof. Vipin Kumar, Department of Mechanical Engineering, University of Washington

### Papers are invited on the following topics with special emphasis on industrial applications:

- Innovation in Foams
- Novel Blowing Agents
- Novel Foaming Technologies
- Nanocomposite Foams
- Sustainability in Foams
- Biodegradable foams
- Foams for Industrial Applications
- Micro and Nanocellular foams

Please send a title and an abstract of your paper, 100-150 words in length, with full contact information to:

Prof. Vipin Kumar [vkumar@uw.edu](mailto:vkumar@uw.edu)

### Key Dates:

- May 1, 2016 – Abstract due.
- May 15, 2016 – Notification of accepted abstracts to all authors
- July 1, 2016 – First version of the paper to be sent to Vipin Kumar ([vkumar@uw.edu](mailto:vkumar@uw.edu))
- August 1, 2016 – Final version of the paper with any revisions due.

The submitted papers will be carefully reviewed. The criteria for selection of papers will be based on significant developments that will bring benefits to the foam industry with highest quality and originality. The best papers will be selected and announced in January 2017. If you have any questions regarding the abstract, topics, or deadlines, please contact the Conference Chair. We look forward to your participation. Thank you.